

Features

- Low profile, small footprint
- Low forward voltage
- High reliability



Schematic Diagram

Mechanical Data

- Case: SOD-523
- Molding compound: UL flammability classification rating 94V-0
- Terminals: Tin-plated; solderability per MIL-STD-202, Method 208

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	40	V
RMS Reverse Voltage	V_{RMS}	28	V
Maximum Average Forward Output Current	$I_{F(AV)}$	0.5	A
Peak Forward Surge Current @ $t=8.3\text{ms}$ Half Sine-wave	I_{FSM}	2	A
Power Dissipation	P_D	200	mW
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	500	$^\circ\text{C}/\text{W}$
Operating Junction Temperature Range	T_J	-55 to +125	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Typ	Max	Unit
Forward Voltage	V_F	$I_F=10\text{mA}$	0.25	-	V
		$I_F=100\text{mA}$	0.35	-	V
		$I_F=500\text{mA}$	-	0.5	V
Reverse Current	I_R	$V_R=40\text{V}$	-	50	μA

Typical Characteristic Curves

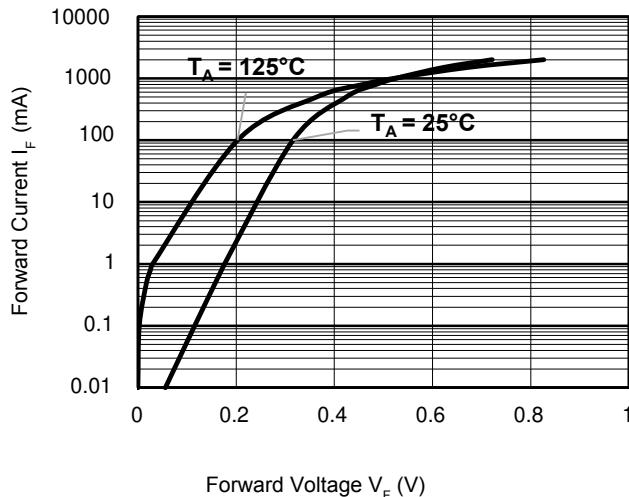


Figure 1. Forward Characteristics

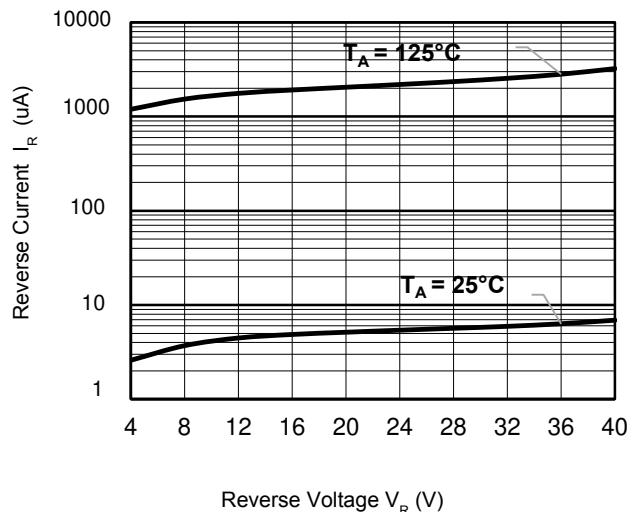


Figure 2. Reverse Characteristics

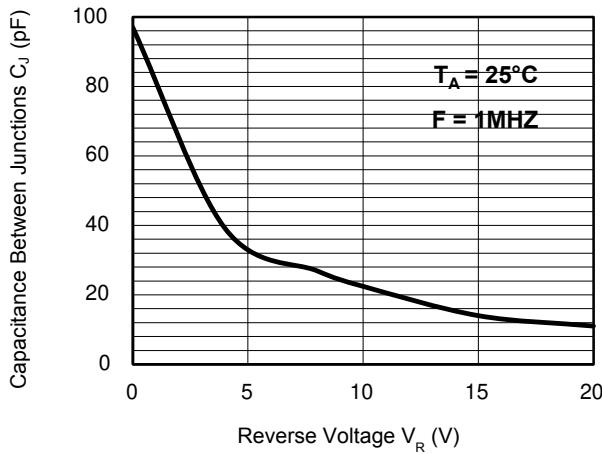
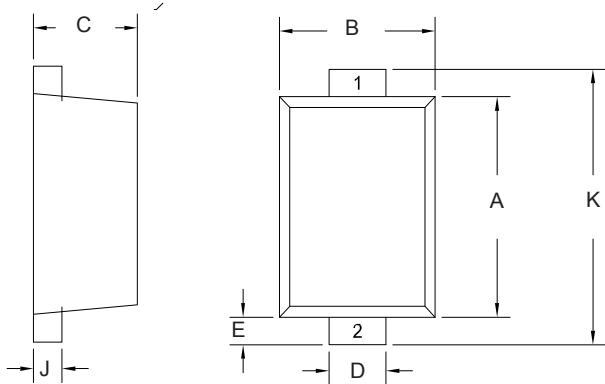


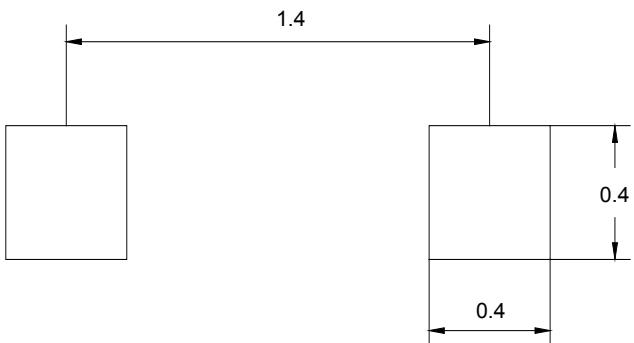
Figure 3. Capacitance Characteristics

Package Outline Dimensions (SOD-523)



Symbol	Dimensions In Millimeters	
	Min	Max
A	1.10	1.30
B	0.70	0.90
C	0.50	0.70
D	0.25	0.35
E	0.15	0.25
J	0.05	0.15
K	1.50	1.70

Recommended Pad Layout



Note:
 1. Controlling dimension: in millimeters.
 2. General tolerance: $\pm 0.05\text{mm}$.
 3. The pad layout is for reference purposes only.

Order Information

MPN	Package	Marking	Carrier	Quantity	HSF Status
GSBT0540X	SOD-523	SF	Tape & Reel	3000pcs / Reel	RoHS compliant